MSB92WT1G, MSB92AWT1G

PNP Silicon General Purpose High Voltage Transistor

This PNP Silicon Planar Transistor is designed for general purpose amplifier applications. This device is housed in the SC-70/SOT-323 package which is designed for low power surface mount applications.

Features

• These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_A = 25°C)

| Rating | Symbol | Value | Unit |
|--------------------------------|----------------------|-----------------------------|------|
| Collector-Base Voltage | V _{(BR)CBO} | -300 | Vdc |
| Collector-Emitter Voltage | V _{(BR)CEO} | -300 | Vdc |
| Emitter-Base Voltage | V _{(BR)EBO} | -5.0 | Vdc |
| Collector Current - Continuous | I _C | 500 | mAdc |
| Electrostatic Discharge | ESD | MBM > 16,000, MM > 2,000 | V |

THERMAL CHARACTERISTICS

| Rating | Symbol | Max | Unit |
|----------------------------|------------------|-------------|------|
| Power Dissipation (Note 1) | P _D | 150 | mW |
| Junction Temperature | TJ | 150 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

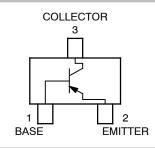
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

 Device mounted on a FR-4 glass epoxy printed circuit board using the minimum recommended footprint.



ON Semiconductor®

http://onsemi.com





SC-70 (SOT-323) CASE 419 STYLE 3

MARKING DIAGRAM



xx = Device Code x= 2D or D2

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation may vary depending
upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|------------|--------------------------------|-----------------------|
| MSB92WT1G | SC-70/ SOT-323 (Pb-Free) | 3000/Tape & Reel |
| MSB92AWT1G | SC-70/ SOT-323 (Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

1

MSB92WT1G, MSB92AWT1G

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Min | Max | Unit |
|---|--|-----------------------|--------------------|------|
| Collector-Emitter Breakdown Voltage (I _C = -1.0 mAdc, I _B = 0) | V _{(BR)CEO} | -300 | - | Vdc |
| Collector-Base Breakdown Voltage ($I_C = -100 \mu Adc, I_E = 0$) | V _{(BR)CBO} | -300 | - | Vdc |
| Emitter-Base Breakdown Voltage $(I_E = -100 \ \mu Adc, I_E = 0)$ | V _{(BR)EBO} | -5.0 | - | Vdc |
| Collector-Base Cutoff Current (V _{CB} = -200 Vdc, I _E = 0) | I _{CBO} | - | -0.25 | μΑ |
| Emitter-Base Cutoff Current $(V_{EB} = -3.0 \text{ Vdc}, I_B = 0)$ | I _{EBO} | - | -0.1 | μΑ |
| DC Current Gain (Note 2) MSB92WT1: $(V_{CE} = -10 \text{ Vdc}, I_{C} = -1.0 \text{ mAdc})$ MSB92AWT1: $(V_{CE} = -10 \text{ Vdc}, I_{C} = -1.0 \text{ mAdc})$ $(V_{CE} = -10 \text{ Vdc}, I_{C} = -10 \text{ mAdc})$ $(V_{CE} = -10 \text{ Vdc}, I_{C} = -30 \text{ mAdc})$ | h _{FE1} h _{FE1} h _{FE2} h _{FE3} | 25 120 40 25 | - 200 - - | - |
| Collector-Emitter Saturation Voltage (Note 2) (I _C = -20 mAdc, I _B = -2.0 mAdc) | V _{CE(sat)} | - | -0.5 | Vdc |
| Base-Emitter Saturation Voltage (I _C = -20 mAdc, I _B = -2.0 mAdc) | V _{BE(sat)} | - | -0.9 | Vdc |
| SMALL SIGNAL CHARACTERISTICS | | | | |
| Current - Gain - Bandwidth Product (I _C = -10 mAdc, V _{CE} = -20 Vdc, f = 20 MHz) | f _T | 50 | - | MHz |
| Collector-Base Capacitance (V _{CB} = -20 Vdc, I _E = 0, f = 1.0 MHz) | C _{cb} | - | 6.0 | pF |

^{2.} Pulse Test: Pulse Width ≤ 300 μs, D.C. ≤ 2%.

MSB92WT1G, MSB92AWT1G

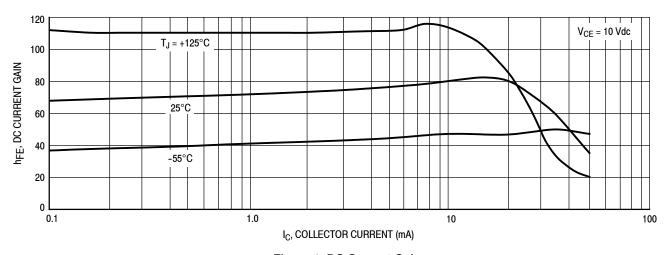


Figure 1. DC Current Gain

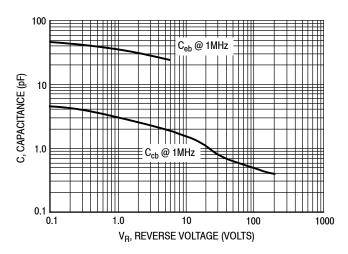


Figure 2. Capacitance

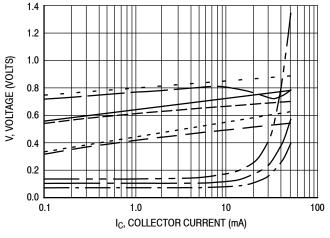
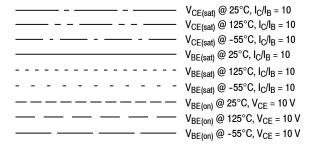


Figure 3. "ON" Voltages







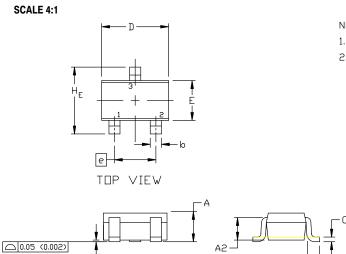
SC-70 (SOT-323) **CASE 419** ISSUE R

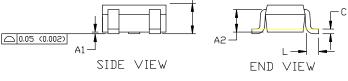
DATE 11 OCT 2022

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|----------|------|--------|-----------|-------|--|
| | MILLIMETERS | | | INCHES | | | |
| DIM | MIN. | N□M. | MAX. | MIN. | N□M. | MAX. | |
| Α | 0.80 | 0.90 | 1.00 | 0.032 | 0.035 | 0.040 | |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 | |
| A2 | | 0.70 REF | | | 0.028 BSC | | |
| b | 0.30 | 0.35 | 0.40 | 0.012 | 0.014 | 0.016 | |
| С | 0.10 | 0.18 | 0.25 | 0.004 | 0.007 | 0.010 | |
| D | 1.80 | 2.00 | 2.20 | 0.071 | 0.080 | 0.087 | |
| E | 1.15 | 1.24 | 1.35 | 0.045 | 0.049 | 0.053 | |
| е | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 | |
| e1 | 0.65 BSC | | | | 0.026 BS | C | |
| L | 0.20 | 0.38 | 0.56 | 0.008 | 0.015 | 0.022 | |
| HE | 2.00 | 2.10 | 2.40 | 0.079 | 0.083 | 0.095 | |





GENERIC MARKING DIAGRAM



= Specific Device Code XX

Μ = Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

| 0.65 [0.025] |
|--------------|
| |
| 1.90 [0.075] |
| 0.90 [0.035] |
| 0.70 [0.028] |

For additional information on our Pb-Free strategy and soldering details, please download the IN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

SOLDERING FOOTPRINT

| STYLE 1: CANCELLED | STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE | STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR | STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE | STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE | |
|-----------------------------|---|---|--|--|---------------------------|
| STYLE 6: | STYLE 7: | STYLE 8: | STYLE 9: | STYLE 10: | STYLE 11: |
| PIN 1. EMITTER | PIN 1. BASE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE | PIN 1. CATHODE |
| 2. BASE | 2. EMITTER | 2. SOURCE | 2. CATHODE | 2. ANODE | CATHODE |
| COLLECTOR | COLLECTOR | 3. DRAIN | CATHODE-ANODE | 3. ANODE-CATHODE | CATHODE |

| DOCUMENT NUMBER: | 98ASB42819B | Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | |
|------------------|-----------------|---|-------------|--|
| DESCRIPTION: | SC-70 (SOT-323) | | PAGE 1 OF 1 | |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights or the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales